



# Product Change Notification

**Change Notification #:** 118314 - 00  
**Change Title:** Select Development Kit/Cable/Programmable Acceleration Card, PCN 118314-00, Product Discontinuance, End of Life  
**Date of Publication:** June 15, 2021

## Key Characteristics of the Change:

Product Discontinuance

## Forecasted Key Milestones:

Last Order Acceptance <sup>(1)</sup>	Last Time Shipments
December 15 <sup>th</sup> , 2021 or until stocks are depleted, whichever is earlier	June 15 <sup>th</sup> , 2022

<sup>(1)</sup> Orders will become non-cancellable, non-reschedulable and non-returnable on the last order acceptance date. For further information on the last time buy terms for each product, please refer to Attachment 1.

## Description of Change to the Customer:

This is the same product discontinuance notice described in PDN2125 issued on June 15, 2021.

Intel is discontinuing Selected Development Kit/Cable/Programmable Acceleration Card ordering codes. A complete list is listed in Attachments 1 below.

### Attachment 1: Discontinued Ordering Code and Last Time Buy Terms

Discontinued Ordering Code	Last Time Buy Terms
DK-DEV-1SMX-H-0ES*	Available while stock lasts
DK-DEV-AGF014E3ES*	Product not available
DK-DEV-AGF014E2ES*	Available while stock lasts
DK-DEV-1SDX-P-0ES*	Product not available
DK-SOC-10AS066S-A*	Available while stock lasts
DK-DEV-AGF0140ES/P*	Product not available
DK-SI-AGF0140ES/P*	Product not available
DK-DEV-1SDX-P-CA*	Product not available
TB-LOAN-1SG10M	Product not available
DK-DEV-1SAX-A-0ES	Available while stock lasts
DK-DEV-AGF014E0ES*	Product not available
PLUSBGUARD	Product not available
PL-ENET-BLASTERZ	Product not available
BD-ACD-10AX1152A*	Product not available
BD-NVV-10AT1151AES*	Product not available
BD-NFV-10AT1151AES*	Product not available

\* Replacement product available – please refer to Attachment 2

#### Attachment 2: Equivalent Ordering Codes

Discontinued Ordering Code	Replacement
DK-DEV-1SMX-H-0ES	DK-DEV-1SMX-H-A
DK-DEV-AGF014E3ES	DK-DEV-AGF014EA
DK-DEV-AGF014E2ES	DK-DEV-AGF014EA
DK-DEV-1SDX-P-0ES	DK-DEV-1SDX-P-A
DK-SOC-10AS066S-A	DK-SOC-10AS066S-D
DK-DEV-AGF0140ES/P	DK-DEV-AGF014EA
DK-SI-AGF0140ES/P	DK-SI-AGF014E3ES
DK-DEV-1SDX-P-CA	DK-DEV-1SDX-P-A
DK-DEV-AGF014E0ES	DK-DEV-AGF014EA
BD-ACD-10AX1152A	BD-ACD-10AX1152B
BD-NVV-10AT1151AES	BD-NVV-N3000-3
BD-NFV-10AT1151AES	BD-NFV-N3000-1

#### Reason for Change

Because of declining demand, the selected products are being phased out.

#### Customer Impact of Change and Recommended Action:

See Attachments 1 and 2 for complete list of the affected OPNs (ordering part numbers). For more information and assistance, please contact Sales or Customer Service in your region.

#### Products Affected / Intel Ordering Codes:

The list of affected OPNs may also be downloaded here:

<https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/pcn/pdn2125-opn-list.xlsx>

#### PCN Revision History:

**Date of Revision:**

June 15, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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